



Product/Process  
Change  
Notification  
**PCN07081**

<b>Product:</b>	DDRII, DDR II low profile, DDR II press fit and FBD Memory Socket.		<b>Part Numbers Concerned:</b>	See list attached
<b>Product Manager:</b>	Alan Chen		<b>Issue Date:</b>	April 26, 2007
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<b>Distribution:</b>	Active and Contract Customers			

**Subject:**

Primary site transfer of DDRII, DDR II low profile, DDR II press fit and FBD Memory Socket to FCI Nantong.

**Nature of Change:**

FCI will be changing the primary manufacturing responsibility from FCI Dongguan, China to FCI Nantong, China for DDRII, DDR II low profile, DDR II press fit and FBD Memory Socket products. The assembly equipment is scheduled to transfer and Nantong will produce product from the assembly tooling built at the plant.

**Product Lines Affected:**

HPL 507

**Implementation Date:**

A phase-in to Nantong produced products will begin during the 2nd quarter of 2007, and will be fully effective by Aug 01, 2007 to be supplying the attachment list in Nantong.

**Affected Part Numbers:**

See attached list

**Recommended Action:**

- Sales teams to inform FCI customers for this product change notification.
- FCI Distributors and sub-contractors should notify end customers as required.
- End customers should remove discontinued part numbers from bills-of-materials (BOM) and consider replacement part numbers.

**For questions regarding this PCN contact:**

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Or contact your nearest FCI representative